



The following clauses, when specifically referenced in the Purchase Order by number, form a part of the Purchase Order in addition to all other clauses, terms, and conditions, drawings and specification, which are also made a part of the Purchase Order. Unless otherwise noted, specifications referenced herein shall be of the issue in effect on the date of the Purchase Order.

DOCUMENTATION CODES

D01 First Article Inspection Report

When listed as a deliverable item on the IDSI purchase order, the supplier is required to submit an electronic copy of a First Article Inspection Report (FAIR) for the relevant part number and revision level listed on the IDSI purchase order. The FAIR format shall comply to the current revision of AS9102. Supplier shall maintain record of FAIR for a minimum of seven (7) years. Shipment of material is contingent on IDSI Quality Assurance acceptance of the submitted report.

If supplier has submitted an FAIR within the previous two (2) years for the part number listed on the IDSI purchase order, but having a different revision level than listed in the purchase order, a delta FAIR may be submitted.

If supplier has submitted an FAIR within the previous two (2) years for part number and revision level listed on the IDSI purchase order, and there has been no change in the manufacturing process or sub-tier suppliers, a new FAIR is not required.

D02 First Piece Dimensional Inspection

Regardless of prior approvals or status, for material on the subject purchase order line, the supplier shall inspect one piece for all dimensional characteristics and notes listed on the drawing, recording all results as objective evidence of the inspection. Recorded data shall be packaged and sent to IDSI with the material in question.

D03 Certificate of Conformance

The supplier shall provide a Certificate of Conformance / Compliance (C of C) with each delivery of product. This C of C is acknowledgement by the supplier that the requirements of the purchase order/subcontract have been fully met and any required chemical / physical analysis has been performed with substantiating evidence/data on file and available upon request by IDSI.

At a minimum, the C of C shall include the following information:

- IDSI Purchase Order Number
- IDSI Part Number and Revision
- Supplier Part Number and Revision (if applicable)
- Part Description/Name
- Quantity



- Serial Number / Lot Code / Date Code / Batch Number (as applicable)
- Supplier Name and Address
- Signature and title of an authorized member of the supplier's Quality department
- Date of issue / approval

If supplier is not the original manufacturer, supplier is responsible for obtaining all necessary information from the original manufacturer. C of C may be part of the packing list, at supplier's discretion.

D04 Certificate of Special Process (SP)

Special Processors shall be accredited by Nadcap. This requirement shall be flowed down to all sub-tier suppliers. Supplier shall provide a Certificate of Conformance (C of C) certifying compliance with all Special Processes (SP) performed as required by this Purchase Order (PO)/Subcontract and any associated specifications and/or drawings. All Special Process suppliers, and sub-tier suppliers, utilized on this purchase order/subcontract shall have current accreditation by Nadcap. The Certificate of Compliance shall document all processes used in satisfying the PO/Subcontract and the Nadcap accreditation code(s) and date of last audit. SP's are as defined in AS9100 and as defined by Nadcap. All costs associated with Nadcap accreditation shall be borne by the Special Processor.

If First Article Inspection Report (FARI) is also imposed by the PO/Subcontract, the SP C of C and other data, such as material certifications and paint gloss readings, will be attached as part of the FAIR. Some examples of special processes are; Chemical Processes (including Plating, Conversion Coating), Heat Treating, Protective Coatings (Conformal/Paint Epoxy), Welding (EG: Resistance/ EB Fusion), Brazing (Vacuum/ Dip), Non-Destructive Inspection or Test (NDI/NDT), Material Testing Laboratories, Composites, Non-conventional Machining & Surface Enhancements, X-Ray Inspection, etc. This records pertaining to this requirement must be maintained by supplier for not less than seven (7) years.

D05 Raw Material Report and/or Certificate of Conformance

The supplier shall provide a Report and/or Certificate of Conformance (C of C), with each delivery, for the raw material supplied or used in the parts supplied. The C of C shall be from the original raw material supplier and include original supplier, lot number, material specification, tests conducted and any other relevant information needed to identify the raw material. Acceptable examples include foundry report, mill report, dimension/ description, temper/hardness, alloy and condition. The supplier shall maintain the original mill certification and any secondary independent test laboratory certification(s) if any additional process was done after original mill certification for procured metallic material that shall include physical properties, chemical analysis and lot number(s). For plastics and other proprietary materials a C of C from the OEM / OCM to that material specification is acceptable. In addition, material must meet any other contractual requirements as stated in the Purchase Order, and any applicable DFARs such as Specialty Metals. Supplier records shall be retained for a minimum of 7 years after completion of the purchase order or subcontract. These requirements shall be flowed down to any sub-tier suppliers.



D06 Test Data by Lot

The supplier shall provide, with each shipment, one reproducible copy of the documented Test Data, including electrical, mechanical, or environmental, as applicable. Lot type data shall be included with each shipment. The supplier shall also retain such records for a minimum of seven (7) years after delivery of product. All retained records shall remain legible, readily identifiable and retrievable. These requirements shall be flowed down to any sub-tier suppliers. Records shall be made available to IDSI, IDSI's customers or government representatives upon request for the duration of the retention period.

D07 Test Data by Serial Number

The supplier shall provide, with each serialized unit, one reproducible copy of the documented Test Data, including electrical, mechanical, or environmental, as applicable. The supplier shall also retain such records for a minimum of seven (7) years after delivery of product. All retained records shall remain legible, readily identifiable and retrievable. These requirements shall be flowed down to any sub-tier suppliers. Records shall be made available to IDSI, IDSI's customers or government representatives upon request for the duration of the retention period.

D08 Retention of Records

Records of product conformity for serialized or lot controlled items shall be retained for a minimum of seven (7) years after delivery of product. All retained records shall remain legible, readily identifiable and retrievable. These requirements shall be flowed down to any sub-tier suppliers. Records shall be made available to IDSI, IDSI's customers or government representatives upon request for the duration of the retention period.

D09 OEM Pedigree Traceability

Original Manufacturer (OEM) lot traceability is required. Each piece delivered in the subject lot shall be clearly marked with a lot code or date code which provides traceability to the manufacturer. If the part is too small to mark, the minimum protective package shall contain the information.

D10 Parts subject to QPL control

The product furnished under this order shall be the product which are listed on the Qualified Products List (QPL) applicable to the product ordered.

D11 Counterfeit Parts Prohibited

No counterfeit parts, as defined herein, shall be used in products supplied to IDSI. Definition:
A) Counterfeit Part: Any part that is a copy or substitute without legal right or authority to do so or one whose material, performance, or characteristics are knowingly misrepresented by a supplier at any level in the supply chain. Examples of counterfeit parts may include, but are not limited to:



- 1) Parts which do not contain the proper internal construction (Die, Manufacturer, Wire Bonding, etc.) consistent with the ordered part;
 - 2) Parts which have been used, refurbished, or reclaimed, but represented as new product;
 - 3) Parts which have a different package style or surface plating/finish than the ordered parts;
 - 4) Parts which have not successfully completed the OEM's full production and test flow, but are not represented as completed product;
 - 5) Parts sold as upscreened parts, which have not successfully completed upscreening; or,
 - 6) Parts sold with modified labeling or markings intended to misrepresent the part's form, fit, function, grade, or manufacturing date.
- B) Part: The lowest level of separately identifiable items (e.g. piece parts).

D12 Prohibition Against Use of Non-Franchised Distributors

All Electrical, Electronic, and Electromechanical (EEE) Parts shall be purchased through Original Component Manufacturer (OCM) / Original Equipment Manufacturer (OEM), or an OCM/OEM-Authorized Distributor (a.k.a. Franchised Distributor). Use of Non-Franchised Distributors is prohibited without expressed written consent by IDSI to include approval of test reports ensuring parts are of OEM design/manufacture and not counterfeit parts.

D13 Interconnect Stress Test (IST)

Subject material must have Interconnect Stress Test performed for Lot Acceptance. Testing shall be compliant to IPC-TM-650 Number 2.6.26, Method A, Dual Sense Testing. Capacitance Testing per Section 5.2.4 is required when capacitance test circuitry is provided on the test coupons. Any coupons failing the IST test shall require failure analysis per Section 6.2. Sample selection, conditioning, pre-conditioning, test conditions and acceptance criteria shall be according to IDSI document 50000-80008 Interconnect Stress Test for PCB Lot Acceptance. Electronic copy of test data report shall be provided to IDSI for each sample lot.

D14.01 X-Ray inspection of Bottom Terminated Components, Process Qualification

Components with solderable bottom terminations (a.k.a. belly terminations) are not adequately addressed in IPC-A-610. Refer to IDSI document QMS-QA-05.04: Special Inspection Acceptance and Repair Requirements for additional information.

X-ray inspection of the bottom termination solder joints is required for Process Qualification at a sampling rate of AQL 1%, Level II, Normal on the first run of any new configuration (defined as any change to assembly revision, stencil artwork, or any other change that may affect the solder paste or SMT reflow process).

D14.02 X-Ray inspection of Bottom Terminated Components, AQL Sampling of Each Lot



Components with solderable bottom terminations (a.k.a. belly terminations) are not adequately addressed in IPC-A-610. Refer to IDSI document QMS-QA-05.04: Special Inspection Acceptance and Repair Requirements for additional information.

X-ray inspection of the bottom termination solder joints is required for Lot Acceptance at a sampling rate of AQL 1%, Level II, Normal on each production run (defined as any continuous operation without change to raw material, or component lots).

D14.03 X-Ray inspection of Bottom Terminated Components, 100%

Components with solderable bottom terminations (a.k.a. belly terminations) are not adequately addressed in IPC-A-610. Refer to IDSI document QMS-QA-05.04: Special Inspection Acceptance and Repair Requirements for additional information.

X-ray inspection of the bottom termination solder joints is required 100% of bottom terminated components.

D14.04 X-Ray inspection of Bottom Terminated Components, Special requirement per SOW or PO

Components with solderable bottom terminations (a.k.a. belly terminations) are not adequately addressed in IPC-A-610. Refer to IDSI document QMS-QA-05.04: Special Inspection Acceptance and Repair Requirements for additional information.

X-ray inspection of the bottom termination solder joints as defined in Statement-of-Work, Purchase Order, or other procurement documentation.

D15.01 X-Ray inspection of Area Array Components, Process Qualification

Area Array Components (including but not limited to Ball Grid Array (BGA), Land Grid Array (LGA), and Column Grid Array (CGA) require X-Ray inspection with acceptance criteria as defined in IPC-A-610.

X-ray inspection of the Area Array component solder joints is required for Process Qualification at a sampling rate of AQL 1%, Level II, Normal on the first run of any new configuration (defined as any change to assembly revision, stencil artwork, or any other change that may affect the solder paste or SMT reflow process).

D15.02 X-Ray inspection of Area Array Components, AQL Sampling of Each Lot

Area Array Components (including but not limited to Ball Grid Array (BGA), Land Grid Array (LGA), and Column Grid Array (CGA) require X-Ray inspection with acceptance criteria as defined in IPC-A-610.



X-ray inspection of the Area Array component solder joints is required for Lot Acceptance at a sampling rate of AQL 1%, Level II, Normal on each production run (defined as any continuous operation without change to raw material, or component lots).

D15.03 X-Ray Inspection of Area Array Components, 100%

Area Array Components (including but not limited to Ball Grid Array (BGA), Land Grid Array (LGA), and Column Grid Array (CGA) require X-Ray inspection with acceptance criteria as defined in IPC-A-610.

X-ray inspection of the Area Array component solder joints is required for 100% of Area Array components.

D15.04 X-Ray Inspection of Area Array Components, Special Requirement per SOW or PO

Area Array Components (including but not limited to Ball Grid Array (BGA), Land Grid Array (LGA), and Column Grid Array (CGA) require X-Ray inspection with acceptance criteria as defined in IPC-A-610.

X-ray inspection of the Area Array component solder joints shall be as defined in Statement-of-Work, Purchase Order, or other procurement documentation.

D16 Radiographic Inspection

The material on this purchase order requires radiographic inspection. Each Radiograph shall include the image of the number, part serial number, identification of the area radiographed and identification of the view direction. Films shall be interpreted by the supplier's laboratory and findings reported on an appropriate form. Copies of the laboratory report and the radiographs shall accompany the material. Each report submitted shall be signed by a certified radiographer, stating the level of certification IAW MIL-STD-410/NAS 410.

D17 Acoustic Microscopy Requirement

Acoustic microscopy shall be performed on all plastic encapsulated components with images identified to individual parts and included in shipment upon delivery to IDSI. Specific requirements for scanning modes and applicable standards are provided on the Purchase Order. A source control drawing (SCD) is recommended.

D18 Notification of Schedule Delay

Supplier shall notify the IDSI buyer, within one (1) working day of discovering any nonconformity, failure, etc. that could jeopardize the delivery schedule required by this Purchase Order.

D19 Change Notification



Supplier shall notify IDSI of proposed changes in design and/or process definition, and shall obtain approval from IDSI Buyer and cognizant Quality authority prior to implementing the change. Changes affecting processes, production equipment, tools, and programs shall be documented.

D20 Authorization to Proceed

Prior to start of manufacturing, supplier must receive formal consent to build from IDSI. Dependent on the IDSI-established complexity of the manufacturing process, this consent will either be conducted at the supplier facility or scheduled as a teleconference. Consent method to be established by IDSI. The timing of this activity shall be included as part of the milestone schedule supplied to IDSI.

D21 DPAS Rating

This is a rated order certified for National Defense Use, and you are required by law to follow the provisions of the Defense Priorities Allocations System (15 CFR 700).

Authorized vendor representative must accept or reject a rated order in writing or electronically within fifteen (15) working days after receipt of a DO rated order, and within ten (10) working days after receipt of a DX rated order. If the order is rejected, the representative must give reasons in writing (NOT electronically) for the rejection, directed to the listed Buyer on the subject order.

If a rated order has been accepted, and vendor/vendor's representative subsequently finds that shipment or performance will be delayed, notification must be provided to IDSI immediately, providing the reasons for the delay, and advising of a new shipment/performance date. If notification is given verbally, written or electronic confirmation must be provided within five (5) working days.

D22 Mixed DPAS Rating

This Purchase Order contains combined Unrated and Rated order quantities certified for National Defense use. Vendor is required to follow all provisions of Defense Priorities and Allocation System (15 CFR part 700) only as it pertains to the rated quantities.

D23 Classified Information Control

Performance under this purchase order involves access to classified information. Approved DD254, Security Requirements Check List, is applicable to this contract, and should be in supplier's possession. All classified end items, components, etc., manufactured or procured by supplier must be shipped in accordance with applicable security regulations.

D24 Requirements Flow Down

Seller shall flow down applicable requirements to all of their suppliers to ensure buyer's requirements, including key characteristics, are appropriately flowed down to all tiers within the supply chain.



D25 Critical Item, Raw Material Test Report and Certification

Raw material used for this purchase order is considered to be a Critical Item. Test Report(s) verifying the key characteristics of the raw material shall be provided to IDSI along with a Certificate of Conformance (C of C) from the original raw material supplier for each delivery. Documentation shall include the name of the the original raw material supplier and include lot number, material specification, tests conducted and any other relevant information needed to identify the raw material. The supplier shall maintain the original mill certification, subsequent special process reports (including heat treatment), all test report(s) and certificates of conformance for a minimum of 7 years after completion of the purchase order or subcontract. These requirements shall be flowed down to any sub-tier suppliers. Test samples suitable for 3rd party testing shall be included in the quantity specified on the purchase order if so indicated.

MATERIAL CODES

M01 Material Subject to Shelf-Life Control

Material in this purchase order is subject to shelf-life control. The following information shall be identified on each container or accompanying documentation:

- 1) Manufacturer's name;
- 2) Product name/designation;
- 3) Shelf life duration period (in months) and shelf life beginning and/or expiration date;
- 4) Cure Date (if subject material is rubber); and,
- 5) Controlled storage conditions/handling instructions (flash point, if applicable) required to achieve stated useful life.

No material shall be shipped to IDSI with less than 80% of its useful shelf life, unless provided written authorization by an IDSI purchasing agent.

M02 Preference for Domestic Specialty Metals

Any articles delivered against this purchase order must comply with the requirements of 48 CFR 252.225-7014. Per the requirement Specialty Metals means

- (i) Steel—
 - (A) With a maximum alloy content exceeding one or more of the following limits: manganese, 1.65 percent; silicon, 0.60 percent; or copper, 0.60 percent; or
 - (B) Containing more than 0.25 percent of any of the following elements: aluminum, chromium, cobalt, columbium, molybdenum, nickel, titanium, tungsten, or vanadium;
- (ii) Metal alloys consisting of nickel, iron-nickel, and cobalt base alloys containing a total of other alloying metals (except iron) in excess of 10 percent;
- (iii) Titanium and titanium alloys; or
- (iv) Zirconium and zirconium base alloys.



M03 Restriction on Acquisition of Certain Articles Containing Specialty Metals

DFAR clause 252.225-7009 applies to this purchase order. Any articles delivered against this purchase order must comply with the requirements of DFAR 252.225-7009.

M04 Workmanship of Electronic Assemblies

The product purchased must meet the soldering and workmanship requirements contained in the latest issue of IPC/ANSI J-STD-001, Class 3 and IPC-A-610 Class 3 unless otherwise specified on the purchase order/subcontract or drawing. In case of a conflict, IPC/ANSI J-STD-001 takes precedence.

M05 PCB Edge Plating Acceptance

Acceptance criteria for Edge Plating and Edge Plating Removal of Printed Circuit boards shall be in accordance with the applicable drawing and IDS document 50000-80007.

M06 Conformance to Solderability Standards

All leads, pins, terminations or terminals on components/parts supplied shall comply with the solderability requirements of J-STD-001. The testing may be performed on leads, pins or packages which are from the same material lot as that used in production parts and which have been exposed to the same environments as the production parts.

M07 Lead Tinning for Gold Removal

Gold shall be removed from the solderable surfaces of electrical and electronic components according to J-STD-001. Supplier shall tin leads with eutectic tin-lead solder (Sn63). Tinning should be no closer than .020 inches to the component body.

M08 Serialization

Serial numbering required.

M09 Printed Circuit Boards

The subject material of this purchase order is printed circuit boards that are to be manufactured to IPC specification(s) and equipment class as noted on the drawing. The following requirements are in addition to those specified.

(1) Acceptance testing and frequency shall be performed as specified in the controlling IPC specification and equipment class as noted on the drawing (i.e. Class 3 or Class 2).



(2) Thermal stress testing of coupons shall be according to IPC-TM-650, Method 2.6.8, Condition A (for thermoset materials) or Condition B (for thermoplastic materials).

(3) Unused test coupons shall be maintained by the manufacturer and available for review for a minimum of 3 years after delivery, for each lot of printed wiring boards shipped against this purchase order.

(4) Each shipment shall include:

- Certificate of Compliance
- Quality Audit Report / Checklist
- Electrical Test Certificate of Compliance
- Micro-section Report
- Plating Thickness Report
- Ionic Contamination / Cleanliness Report
- First Article Report (for initial production run of part number and revision)
- Microsection Samples (unless previously provided)
- Solder Sample(s) (unless previously provided)

M10 No Pure Tin, Bismuth or SAC Alloyed Materials Allowed

No pure tin plating allowed. The use of pure unalloyed tin is prohibited in the construction and surface finish of goods required to be delivered under this Purchase Order. Construction and finish include solders and plating. Tin is considered to be pure if it contains less than 3% alloying elements. The critical concentration of bismuth begins in the range of 3 to 5%, so lead finishes with greater than 3% bismuth are not allowed. BGA's and CCGA's are not allowed with Tin-Silver-Copper (SAC) alloyed balls. Data / Certification to this requirement must be maintained by the OEM / OCM and is not required to be submitted with each shipment unless otherwise specified. These certifications must be provided upon request by IDSI.

M11 Prohibition on Pure Tin Plating

Pure Tin (Sn) plating is prohibited as a final finish or as an undercoat. Tin-lead (Sn-Pb) finishes are acceptable provided that the minimum lead content is three (3) percent.

M12 Mercury Exclusion

Mercury or mercury-containing compounds shall not be intentionally added or come in direct contact with hardware or supplies furnished under this purchase order.

M13 Certification on Prohibited Materials

Product on this order requires prohibition of certain materials: Tin, Cadmium, or Zinc plating, as a final finish or as an undercoat. Tin-Lead (Sn-Pb) finishes are acceptable provided the minimum lead content is three percent (3%) by weight. For all prohibited materials listed on this Purchase Order, supplier is



required to submit a certificate attesting that all products provided comply with the exclusion clause. At a minimum, the certificate shall include the following information:

- 1) Supplier CAGE code;
- 2) Lot/heat/batch/date code and serial numbers (if applicable);
- 3) IDSI order number;
- 4) Part number of material;
- 4) Name and address of manufacturing location;
- 5) Quantity and unit of measure;
- 6) Statement of exclusion specific to the materials listed on the order's prohibited materials; and,
- 7) Signature of an authorized member of the supplier's Quality department.

If supplier to IDSI is not the original manufacturer, supplier is responsible for obtaining all necessary information from the original manufacturer.

M14 Prohibition on Pure Metal Plating

Pure metal plating of Tin (Sn), Cadmium (Cd), or Zinc (Zn) are prohibited as a final finish or as an undercoat. Tin-Lead (Sn-Pb) finishes are acceptable provided they have a minimum content of three percent (3%) Lead (Pb) by weight. Supplier shall flow down this requirement to their sub-tier suppliers.

M15 Prohibited Materials

Supplies furnished under this contract or purchase order shall not contain any of the following:

1. Pure Tin: Unalloyed tin or tin plate where tin is greater than 97% pure and the remainder is lead is prohibited. Tin with less than 97% tin and the remainder is lead is acceptable. Reflowed pure tin plating is not acceptable.
2. Cadmium: Pure Cadmium and high Cadmium alloys ($\geq 15\%$ Cadmium) are prohibited.
3. Zinc: Pure zinc and high zinc alloys ($\geq 15\%$ Zinc) are prohibited
4. Mercury: Pure mercury and high mercury alloys ($\geq 15\%$ Mercury) are prohibited
5. Selenium: Pure selenium and high selenium alloys ($\geq 15\%$ Selenium) are prohibited
6. Corrosive solder flux: Active rosin and organic acid fluxes are prohibited on closed surfaces such as a wire termination (stranded wire).
7. Magnesium: Pure magnesium or high magnesium alloys. Magnesium alloy may be acceptable with a maintained protective coating of Dow 17 or equivalent coating. Trace amounts of Mg are acceptable in material systems such as Aluminum and Steel alloys.
8. Polyvinyl Chloride (PVC): No forms of PVC are acceptable.
9. Potting and foam formulations that is prone to reversion.
10. Polyurethane or silicone compounds that is prone to reversion.
11. Silicones that release acetic acid or other corrosive products during the cure process.
12. Cyanoacrylate bonding as primary adhesives. In-process bonding is acceptable provided an approved adhesive provides the primary bond support.
13. Graphite as filler for lubricants or grease.



QUALITY CODES

14. Elastomeric materials that contact hydrazine except for F-E-332 for diaphragms and AF-E-411 for soft valve seats. Materials that have known compatibility by test, usage, or similarity are acceptable.
15. Silicone greases intended for thermal bonding for end-item design (not test).
16. Flammable materials that are not packaged to preclude accidental fire.
17. Honeycomb, metallic or non-metallic, except when perforated or vented.
18. Radioactive materials.
19. Silver-plated copper wire with less than 40 micro inches of silver plating.
20. Polyimide (Kapton) insulated copper/copper alloy wire used in applications where the voltage is greater than 18 volts and where flexure, tight bend radii, physical or chemical damage, or abrasion could crack the insulation.
21. Teflon (tetrafluoroethylene-TFE) insulated hookup wire when not routed or protected to prevent cold flow.
22. Fluorinated Ethylene Propylene (FEP) tubing where it provides the sole insulation for a wire conductor and is routed or contacts adjacent metal conductors.

If any of these requirements are not met please provide the specific material and its percentage as applicable.

PACKAGING CODES

P01 ESD Protective Packaging

The product(s) to be furnished under this order line that are susceptible to damage from Electrostatic Discharge (ESD) and must be packaged to prevent damage through all phases of production, transport and storage according to ANSI/ESD S541-2008.

P02 Antistatic Packaging

The product(s) to be furnished under this order line are not susceptible to damage from Electrostatic Discharge (ESD); however they are intended for use in close proximity to ESD sensitive devices and assemblies. Therefore all piece part level packaging of the product(s) furnished under this order line shall be Antistatic (i.e. Low Charging) according to ANSI/ESD S541-2008.

P03 Packaging of Printed Circuit Boards

All Printed Circuit Boards furnished under this purchase order shall be packaged according to IPC-1601A. Moisture content of the PCB prior to packaging should not exceed 0.2% by weight. All PCBs shall be dry packed in heat-sealed Moisture Barrier Bags (MBB) with desiccant and Humidity Indicator Card (HIC). The HIC should have 3 color spots with sensitivity values of 5%, 10% and 60% and should be sulfur-free in accordance with IPC/JEDEC J-STD-033. Separation sheets used between printed boards shall be sulfur and chlorine free and pH neutral. Immersion Silver printed boards shall include protective sulfur absorbing paper (such as Silver Saver™ paper) in the package, covering all exposed silver surfaces. Each MBB shall be marked with the part number, part revision, date code and quantity of PCBs enclosed.



Each MBB should be large enough to cut open and re-seal twice. Sealable edges of MBB shall not be taped or have labels that would interfere with heat sealing.

P04 Special Packaging for Silver Material

Silver or silver-plated parts are to be wrapped in tarnish-retardant paper (such as silver saver) or sealed in a suitable non-sulfur-bearing container prior to final packaging for shipment. Where part size or quantity preclude individual wrap (e.g., terminals), non-damaging bulk wrap techniques will be acceptable. Packing list or other prominent package marking should identify material as silver or silver-plated.

P05 Specialized Waffle Pack for Dies

Supplier to ship these die in 2X2 inch static dissipative waffle packs (Fluoroware H20 series Chip Sentry or equivalent). The color will be black for all die except black encapsulated die (use white). The cavity width and length shall be less than the diagonal length of the die. The depth shall be no more than 1.5X the height of the die. No tapered walls. Polarized parts must be clearly marked on top surface. Loading of the die must start in the bottom-left cavity (waffle pack notch in top left corner) and proceed up each column. Each waffle pack must have its own lid. The waffle pack label must specify the manufacturer's name, part number, and lot date code. Tyvek paper must be used in all waffle packs and die must be stored in dry nitrogen. Die shall not be packaged in gel packs.

P06 Covers and Housing Packaging

Covers and Housings must be separately packaged in individual Antistatic bags (i.e. Low Charging) according to ANSI/ESD S541-2008. Identification labels must be placed on the shipping container and each individual Antistatic bag. The labels must note the part number, drawing revision, and quantity enclosed within the package/container.

QUALITY SYSTEM CODES

Q01 Supplier Quality Management System

IDSI, LLC operates under a Quality Management System (QMS) certified to AS9100D. We evaluate our suppliers to the requirements of this international standard. Suppliers to IDSI shall operate under a suitable QMS; preferably AS9100, alternatively ISO9001. The supplier's QMS system should be certified by a third party Certification Body, listed with the International Aerospace Quality Group (IAQG) or accredited by an International Accreditation Forum (IAF) affiliated accreditation body. Supplier Quality Management Systems that do not meet the preferred conditions may be subject to audit by IDSI or their customers. IDSI reserves the right to review and approve the supplier's manufacturing processes, controls, and records associated with the manufacture of subject material.

Q02 Counterfeit Electronic Parts Detection and Avoidance Plan



Supplier shall maintain a Counterfeit Electronic Parts Detection and Avoidance Plan internally and with its suppliers that is consistent with applicable requirements of 48 CFR 252.246-7007. SAE AS5553 may also be used as guide. Supplier shall immediately notify IDSI with the pertinent facts if supplier becomes aware or suspects that items delivered in accordance with the IDSI purchase order contain counterfeit parts. When requested by IDSI, supplier shall provide OCM/OEM documentation that authenticates traceability of electronic parts to the applicable OCM/OEM.

Q03 Supplier ESD Control Program

Supplier shall maintain an Electrostatic Discharge (ESD) Control Program that complies with ANSI/ESD-S20.20-2014. The supplier's ESD Control Program shall be subject to review and audit by the IDSI, its customers, and/or government representative.

Q04 Foreign Object Damage (FOD) Prevention Program

Supplier shall maintain an effective Foreign Object Damage (FOD) Prevention Program. The supplier's program shall utilize effective FOD prevention practices. The program shall be proportional to the sensitivity of the design of the product(s) to FOD, as well as, to the FOD generating potential of the manufacturing methods. NAS412 may serve as a guideline. The supplier's FOD Prevention Program shall be subject to review and audit by the IDSI, its customers, and/or government representative.

Q05 Supplier Calibration System Compliance Requirements

Supplier shall have a calibration system which complies with the requirements of ISO/IEC 17025 and ANSI/NCSL Z540-1. The supplier's calibration system is subject to review and audit by the IDSI, its customers, and/or government representative.

SOURCE INSPECTION CODES

S01 Source Inspection, Final

Final Source Inspection is required on all shipments against this line item at the supplier's facility prior to shipment. The supplier shall provide the necessary facilities, equipment, qualified personnel, and documentation to demonstrate conformance to the order requirements during this inspection, including final testing. At the time of source inspection a copy of the IDSI PO, latest Drawing & PL, latest Change Notices, and other applicable specifications shall be presented. The parts or devices shall be ready for shipment except for any packaging that may interfere with the inspection/test. The supplier shall provide notice to IDSI seven (7) business days in advance of inspection readiness in advance thereof. After completion of successful and accepted source inspection, a copy of the completed Source Inspection Report and all other required data shall be packaged and shipped with the parts.

S02 Source Inspection, Pre-Cap



Pre-closure (a.k.a. pre-cap) Source Inspection is required on all shipments against this line item at the supplier's facility prior to shipment. The supplier shall provide the necessary facilities, equipment, qualified personnel, and documentation to demonstrate conformance to the order requirements during this inspection, including final testing. At the time of source inspection a copy of the IDSI PO, latest Drawing & PL, latest Change Notices, and other applicable specifications shall be presented. The parts or devices shall be ready for final internal visual inspection without the final cover or closure. The supplier shall provide notice to IDSI seven (7) business days in advance of inspection readiness in advance thereof. After completion of successful and accepted source inspection, a copy of the completed Source Inspection Report and all other required data shall be packaged and shipped with the parts.

S03 Source Inspection, Final, Limited

Final Source Inspection is required on the initial shipments against this line item at the supplier's facility prior to shipment. Quantity for inspection to be agreed upon between IDSI and supplier. The supplier shall provide the necessary facilities, equipment, qualified personnel, and documentation to demonstrate conformance to the order requirements during this inspection, including final testing. At the time of source inspection a copy of the IDSI PO, latest Drawing & PL, latest Change Notices, and other applicable specifications shall be presented. The parts or devices shall be ready for shipment except for any packaging that may interfere with the inspection/test. The supplier shall provide notice to IDSI seven (7) business days in advance of inspection readiness in advance thereof. After completion of successful and accepted source inspection, a copy of the completed Source Inspection Report and all other required data shall be packaged and shipped with the parts.

S04 Source Inspection, Pre-Cap, Limited

Pre-closure (a.k.a. pre-cap) Source Inspection is required on the initial shipments against this line item at the supplier's facility prior to shipment. Quantity for inspection to be agreed upon between IDSI and supplier. The supplier shall provide the necessary facilities, equipment, qualified personnel, and documentation to demonstrate conformance to the order requirements during this inspection, including final testing. At the time of source inspection a copy of the IDSI PO, latest Drawing & PL, latest Change Notices, and other applicable specifications shall be presented. The parts or devices shall be ready for final internal visual inspection without the final cover or closure. The supplier shall provide notice to IDSI seven (7) business days in advance of inspection readiness in advance thereof. After completion of successful and accepted source inspection, a copy of the completed Source Inspection Report and all other required data shall be packaged and shipped with the parts.

MISCELLANEOUS CODES

X01 Additional Quality Notes

Additional quality requirements as specified in the Statement of Work, or Purchase Order apply.



CHANGE LOG

DATE	Description of change
13 Oct 2017	Original Release
24 Oct 2018	Revised D01 First Article Inspection Report, Change Log added